

**SPI-315-34****SANYO****Ultraminiature photoreflector  
(single-transistor type)****Features**

- Infrared LED plus Phototransistor (single)
- DIP type
- Compact type : 3.4 (L) × 2.7 (W) × 1.5 (H) mm
- Visible light cut type
- Lead length : (L=3.5mm)

**Absolute Maximum Ratings at Ta=25°C, 65%RH**

| Parameter                |                           | Symbol    | Rating      | Unit |
|--------------------------|---------------------------|-----------|-------------|------|
| Input LED                | Forward Current           | $I_F$     | 50          | mA   |
|                          | Reverse Voltage           | $V_R$     | 5           | V    |
|                          | Power Dissipation         | $P_D$     | 70          | mW   |
| Output Phototransistor   | Collector-Emitter Voltage | $V_{CEO}$ | 20          | V    |
|                          | Emitter-Collector Voltage | $V_{ECO}$ | 5           | V    |
|                          | Collector Current         | $I_C$     | 20          | mA   |
|                          | Power Dissipation         | $P_C$     | 70          | mW   |
| Operating Temperature    |                           | $T_{opr}$ | -20 to +80  | °C   |
| Storage Temperature      |                           | $T_{stg}$ | -30 to +100 | °C   |
| Soldering Temperature *1 |                           | $T_{sol}$ | 260         | °C   |

\*1 Soldering conditions : time : max. 3sec; clearance : min. 1mm from lower case edge.

**Electro-Optical Characteristics at Ta=25°C, 65%RH**

| Parameter |                                      | Symbol        | Condition                                | Min. | Typ. | Max. | Unit          |
|-----------|--------------------------------------|---------------|------------------------------------------|------|------|------|---------------|
| Input     | Forward Voltage                      | $V_F$         | $I_F=10\text{mA}$                        | 1.0  | 1.2  | 1.6  | V             |
|           | Reverse Current                      | $I_R$         | $V_R=5\text{V}$                          | -    | -    | 10   | $\mu\text{A}$ |
| Output    | Dark Current                         | $I_{CEO}$     | $I_F=0\text{mA}, V_{CE}=10\text{V}$      | -    | -    | 200  | nA            |
| Coupled   | Collector Output Current             | $I_C$         | $I_F=10\text{mA}, V_{CE}=5\text{V}^{*1}$ | 80   | -    | 1100 | $\mu\text{A}$ |
|           | Leakage Current                      | $I_{LEAK}$    | $I_F=10\text{mA}, V_{CE}=5\text{V}^{*2}$ | -    | -    | 1    | $\mu\text{A}$ |
|           | Collector Emitter Saturation Voltage | $V_{CE(sat)}$ | $I_F=10\text{mA}, I_C=50\mu\text{A}$     | -    | -    | 0.5  | V             |
|           | Rise Time                            | $t_r$         | $V_{CC}=5\text{V}, R_L=100\Omega$        | -    | 5    | -    | $\mu\text{s}$ |
|           | Fall Time                            | $t_f$         | $I_C=1\text{mA}$                         | -    | 5    | -    | $\mu\text{s}$ |

\*1 Location of reflector is shown in Fig. 1.

\*2 No reflector

\*3 Table of Classification of Collector Output

| Class               | A           | B          | C          | D         |
|---------------------|-------------|------------|------------|-----------|
| $I_C (\mu\text{A})$ | 1100 to 450 | 600 to 260 | 350 to 150 | 200 to 80 |

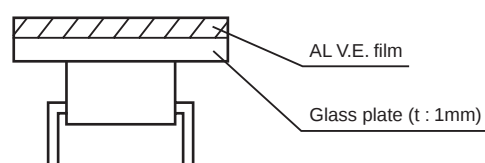


Fig. 1 Location of Reflector

## Package dimensions and Pin connection

As stated in the sttached paper. (No.6028 4/6)

## Lot marking

Color division shall be done as shown in the drawing. (Fig. 2)

Year of even number : Front side

Year of odd number : Back side

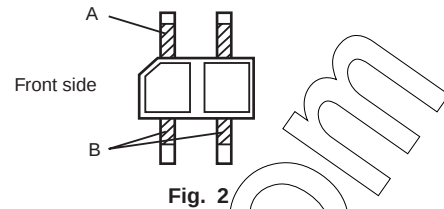


Fig. 2

| Color    | Black   | Blue     | Red       | Green   | Orange   | Brown    |
|----------|---------|----------|-----------|---------|----------|----------|
| Part 'A' | January | February | March     | April   | May      | June     |
| Part 'B' | July    | August   | September | October | November | December |

## Soldering conditions

- (1) Temperature : Max. 260°C
- (2) Time : Max. 3sec
- (3) Clearance : Min. 1mm from the case edge. (Fig. 3)

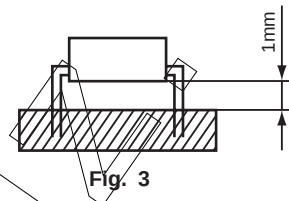
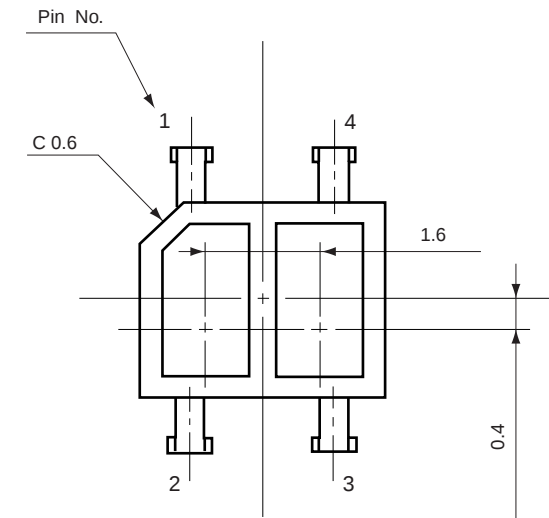


Fig. 3

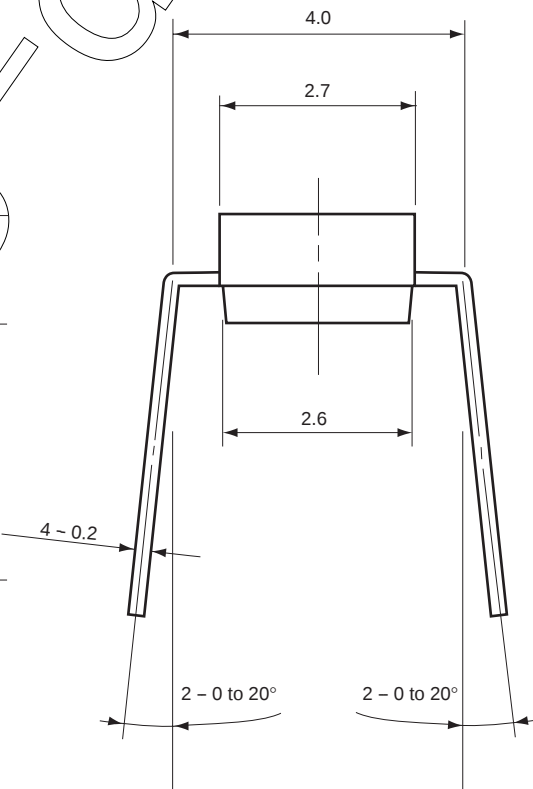
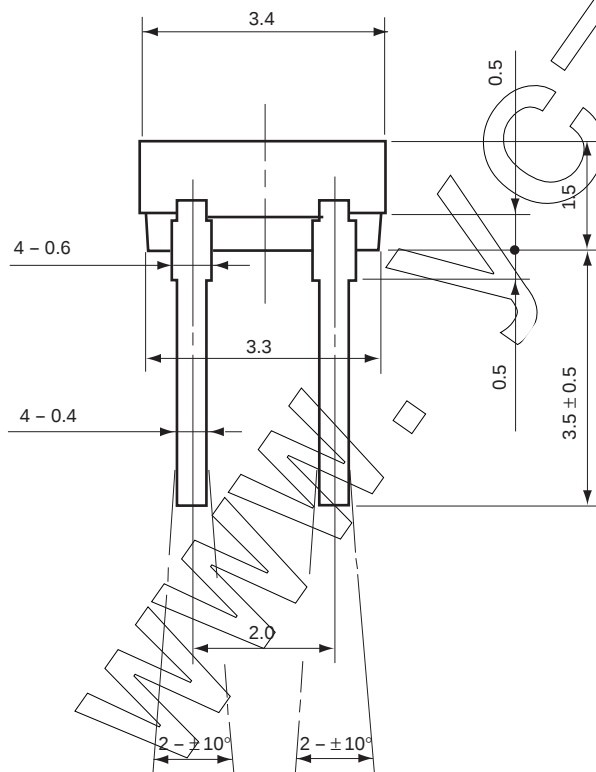
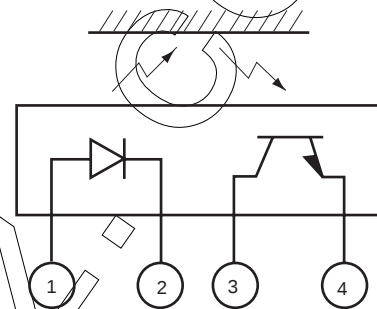
## ⚠ PRECAUTIONS

- (1) Bending a lead should avoid. However, when bending is necessary, take care the next items.
  - ① Bending a lead must be done before soldering.
  - ② Bending a lead must be done in the states of fixing leads and no stress for the regin part. Because it is possible that stress for the regin part cause troubles such as gold wire breaking and so on.
  - ③ A lead must be bend at intervals of 1mm from the case edge.
  - ④ Do not bend the same position of leads more than twice.
- (2) The hole pitch of a circuit board must fit to the lead pitch.
- (3) Take core the following when soldering.
  - ① Do not heat a product under any stress (a twist and so on) to leads.
  - ② Do not heat a product in the states of operating force to the regin part.
- (4) Use the flux which contain no chlorine, have no corrosion and do not need washing.
- (5) Be careful that flux or other chemicals do not attach to the luminous surface and passive surface.



Pin connection

1. LED Anode
2. LED Cathode
3. Ph. Tr Collector
4. Ph. Tr Emitter

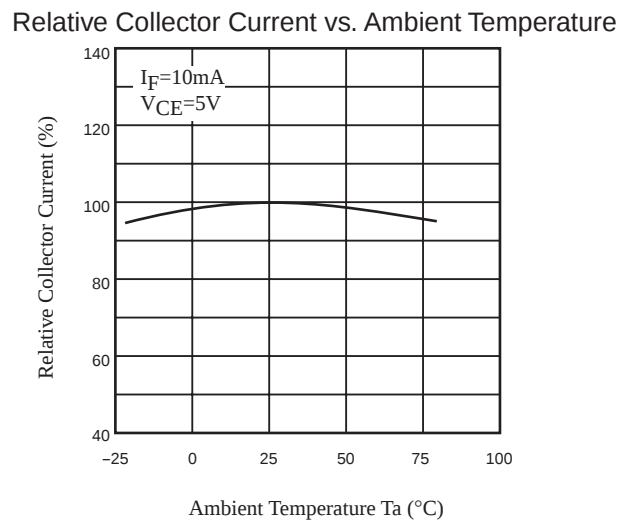
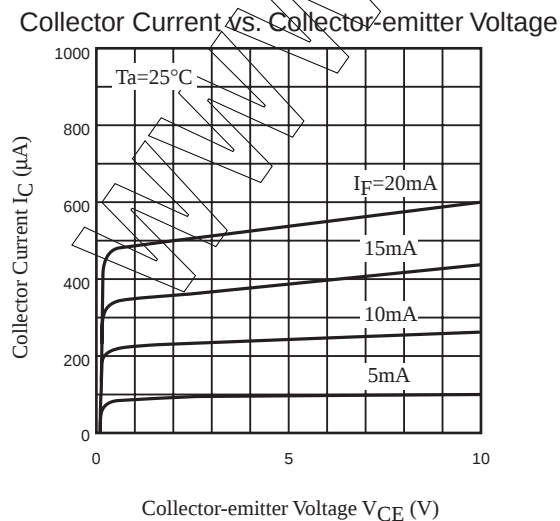
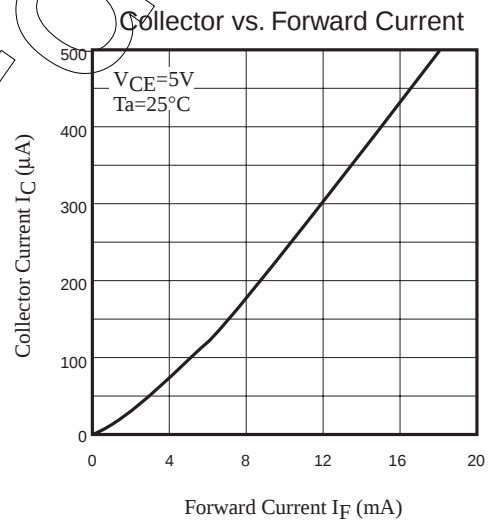
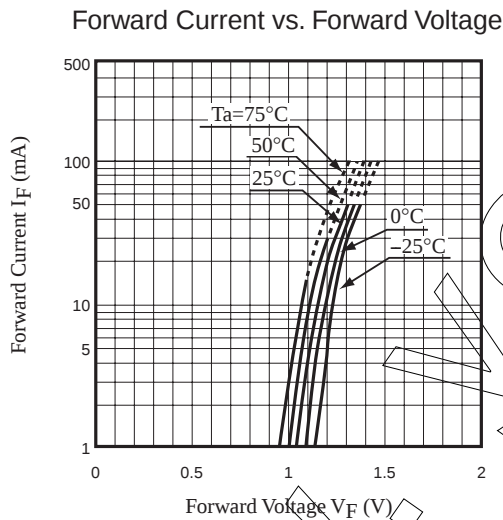
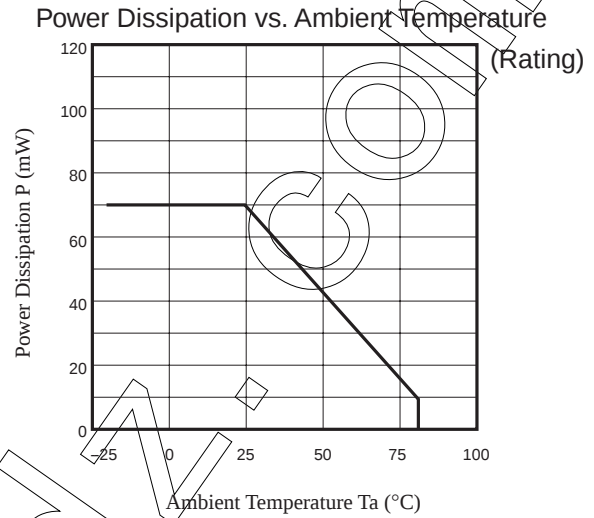
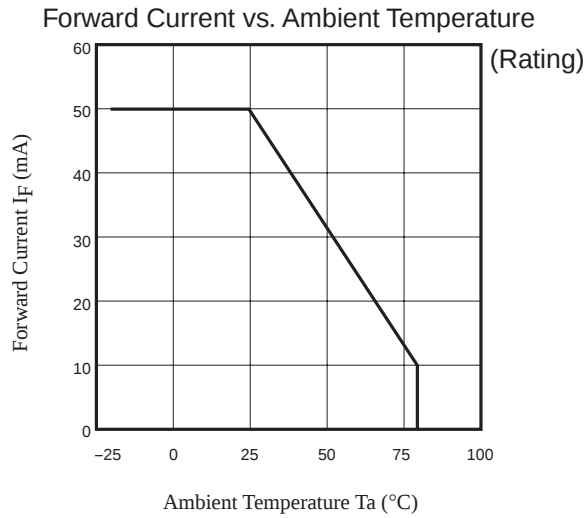


Tolerance : ±0.2  
Unit : mm

## Typical Characteristics



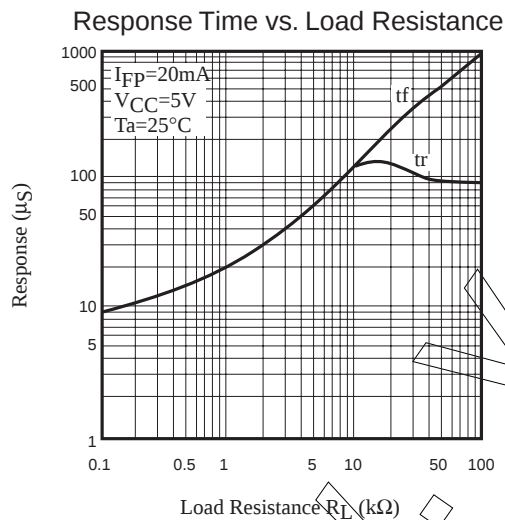
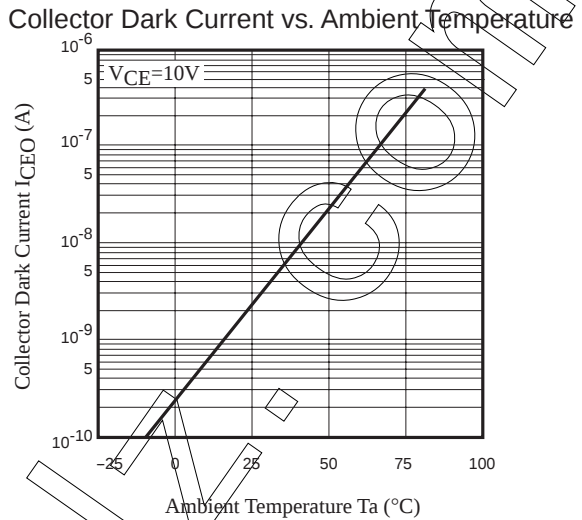
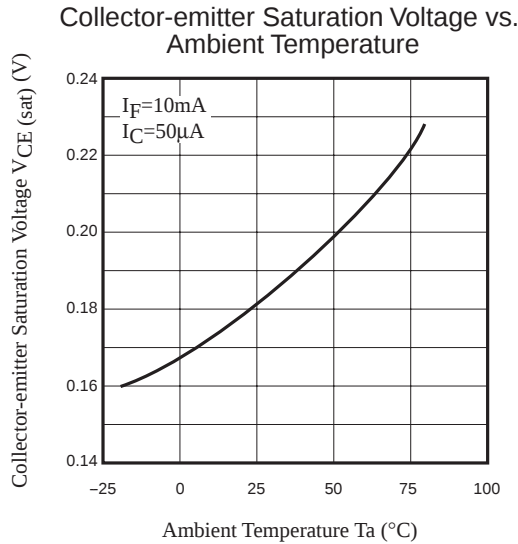
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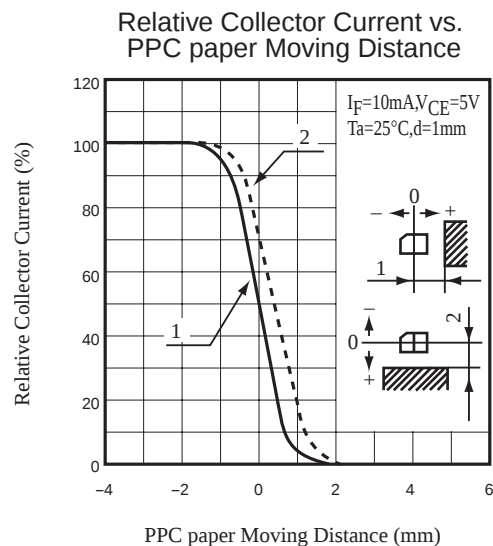
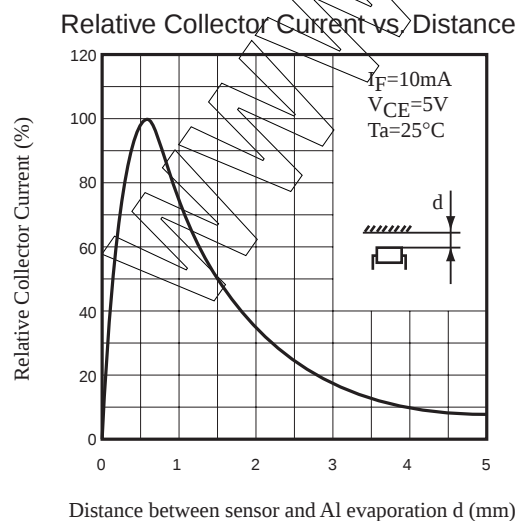
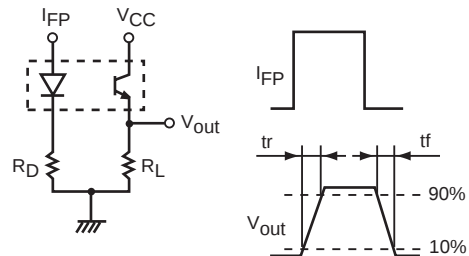
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Test Circuit for Response Time



## CAUTION

1. No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster / crime-prevention equipment or the like, and the failure of which may directly or indirectly cause injury, death or property loss.
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## Precautionary instructions in handling gallium arsenic products

Special precautions must be taken in handling this product because it contains, gallium arsenic, which is designated as a toxic substance by law. Be sure to adhere strictly to all applicable laws and regulations enacted for this substance, particularly when it comes to disposal.

Manufactured by ; **Tottori SANYO Electric Co., Ltd.**

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